

## **MOSFET**

## OptiMOS<sup>™</sup> 5 Power-Transistor, 100 V

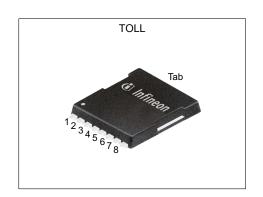
### **Features**

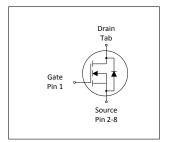
- Ideal for high frequency switching and sync. rec.
  Excellent gate charge x R<sub>DS(on)</sub> product (FOM)
  Very low on-resistance R<sub>DS(on)</sub>
  N-channel, normal level

- 100% avalanche tested
- Pb-free plating; RoHS compliant
  Qualified according to JEDEC<sup>1)</sup> for target applications
  Halogen-free according to IEC61249-2-21



Parameter	Value	Unit	
<b>V</b> <sub>DS</sub>	100	V	
R <sub>DS(on),max</sub>	1.5	mΩ	
I <sub>D</sub>	353	A	
Q <sub>oss</sub>	213	nC	
Q <sub>G</sub> (0V10V)	169	nC	











Type / Ordering Code	Package	Marking	Related Links
IPT015N10N5	PG-HSOF-8	015N10N5	-

# OptiMOS<sup>™</sup> 5 Power-Transistor, 100 V



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## OptiMOS<sup>™</sup> 5 Power-Transistor, 100 V IPT015N10N5



# 1 Maximum ratings at $T_A$ =25 °C, unless otherwise specified

Table 2 Maximum ratings

Davamatar	0	Values			11	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current <sup>1)</sup>	I <sub>D</sub>	- - -	-	353 250 35	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =40 K/W <sup>2)</sup>
Pulsed drain current <sup>3)</sup>	I <sub>D,pulse</sub>	-	-	1412	Α	<i>T</i> <sub>C</sub> =25 °C
Avalanche energy, single pulse <sup>4)</sup>	<b>E</b> AS	-	-	775	mJ	$I_{\rm D}$ =150 A, $R_{\rm GS}$ =25 $\Omega$
Gate source voltage	V <sub>GS</sub>	-20	-	20	V	-
Power dissipation	P <sub>tot</sub>	-	-	375	W	<i>T</i> <sub>C</sub> =25 °C
Operating and storage temperature	T <sub>j</sub> , T <sub>stg</sub>	-55	-	175	°C	-

#### 2 Thermal characteristics

Table 3 Thermal characteristics

Devementes	Cumbal	Values			11	Neder / Teled Orangidian	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Thermal resistance, junction - case	R <sub>thJC</sub>	-	0.2	0.4	K/W	-	
Device on PCB, minimal footprint	R <sub>thJA</sub>	-	-	62	K/W	-	
Device on PCB, 6 cm² cooling area²)	R <sub>thJA</sub>	-	-	40	K/W	-	

<sup>&</sup>lt;sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.  $^{2)}$  Device on 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm $^{2}$  (one layer, 70  $\mu$ m thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

<sup>&</sup>lt;sup>4)</sup> See Diagram 13 for more detailed information

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## 3 Electrical characteristics

at T<sub>j</sub>=25 °C, unless otherwise specified

**Table 4** Static characteristics

Damain Adam	0	Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	100	-	-	V	V <sub>GS</sub> =0 V, I <sub>D</sub> =1 mA
Gate threshold voltage	V <sub>GS(th)</sub>	2.2	3.0	3.8	V	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =280 μA
Zero gate voltage drain current	I <sub>DSS</sub>	-	0.1 10	5 100	μΑ	V <sub>DS</sub> =100 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =25 °C V <sub>DS</sub> =100 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =125 °C
Gate-source leakage current	I <sub>GSS</sub>	-	10	100	nA	V <sub>GS</sub> =20 V, V <sub>DS</sub> =0 V
Drain-source on-state resistance	R <sub>DS(on)</sub>	-	1.3 1.6	1.5 2.0	mΩ	V <sub>GS</sub> =10 V, I <sub>D</sub> =150 A V <sub>GS</sub> =6 V, I <sub>D</sub> =75 A
Gate resistance <sup>1)</sup>	R <sub>G</sub>	-	1.4	2.1	Ω	-
Transconductance	<b>g</b> fs	140	280	-	S	$ V_{DS}  > 2 I_D R_{DS(on)max}, I_D = 100 A$

Table 5 Dynamic characteristics

Danamatan	Ob. a.l		Values			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance <sup>1)</sup>	C <sub>iss</sub>	-	12000	16000	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =50 V, f=1 MHz
Output capacitance <sup>1)</sup>	Coss	-	1800	2300	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =50 V, f=1 MHz
Reverse transfer capacitance <sup>1)</sup>	C <sub>rss</sub>	-	80	140	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =50 V, f=1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	36	_	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.8 $\Omega$
Rise time	t <sub>r</sub>	-	30	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.8 $\Omega$
Turn-off delay time	$t_{ m d(off)}$	-	85	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.8 $\Omega$
Fall time	t <sub>f</sub>	-	30	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.8 $\Omega$

Table 6 Gate charge characteristics<sup>2)</sup>

Parameter	O. mak al		Values			N 4 17 40 1111
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q <sub>gs</sub>	-	53	-	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Gate charge at threshold	$Q_{g(th)}$	-	36	-	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Gate to drain charge <sup>1)</sup>	Q <sub>gd</sub>	-	34	51	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Switching charge	Q <sub>sw</sub>	-	51	-	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total <sup>1)</sup>	Qg	-	169	211	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Gate plateau voltage	$V_{ m plateau}$	-	4.4	-	V	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total, sync. FET	Q <sub>g(sync)</sub>	-	146	-	nC	V <sub>DS</sub> =0.1 V, V <sub>GS</sub> =0 to 10 V
Output charge <sup>1)</sup>	Qoss	-	213	284	nC	V <sub>DD</sub> =50 V, V <sub>GS</sub> =0 V

 $<sup>^{1)}</sup>$  Defined by design. Not subject to production test.  $^{2)}$  See "Gate charge waveforms" for parameter definition

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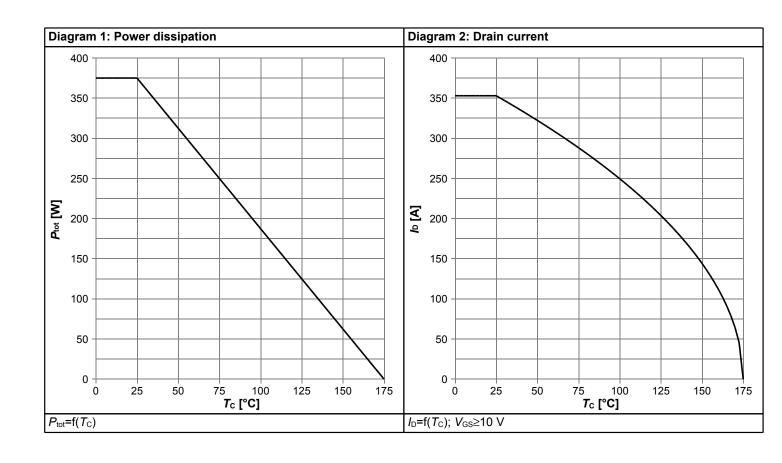


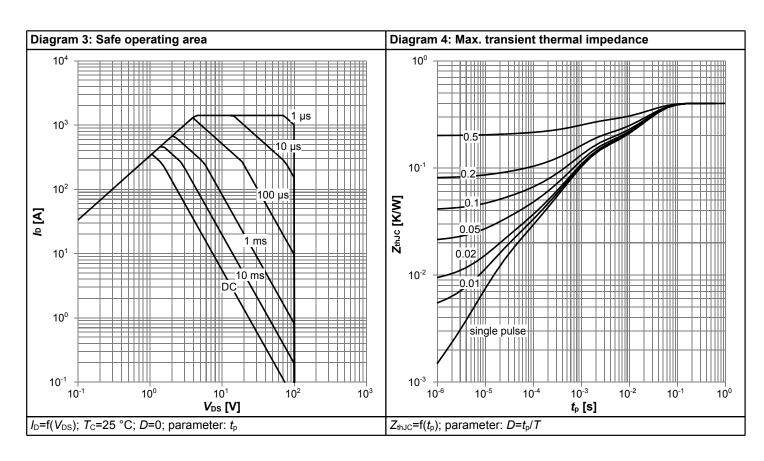
## Table 7 Reverse diode

Devementer	Symbol		Values			Note / Took Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	I <sub>S</sub>	-	-	242	Α	T <sub>C</sub> =25 °C
Diode pulse current	I <sub>S,pulse</sub>	-	-	1412	Α	T <sub>C</sub> =25 °C
Diode forward voltage	V <sub>SD</sub>	-	0.85	1.2	V	V <sub>GS</sub> =0 V, I <sub>F</sub> =100 A, T <sub>j</sub> =25 °C
Reverse recovery time <sup>1)</sup>	t <sub>rr</sub>	-	103	206	ns	V <sub>R</sub> =50 V, I <sub>F</sub> =100A, di <sub>F</sub> /dt=100 A/μs
Reverse recovery charge <sup>1)</sup> Q <sub>rr</sub> -		-	316	632	nC	V <sub>R</sub> =50 V, I <sub>F</sub> =100A, di <sub>F</sub> /dt=100 A/μs

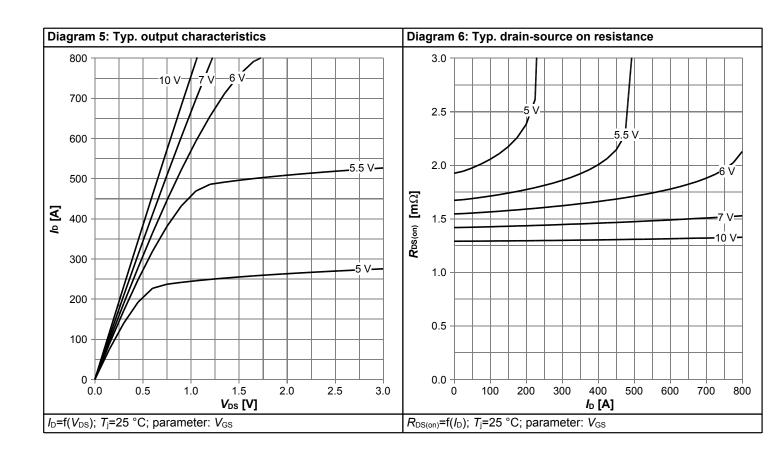


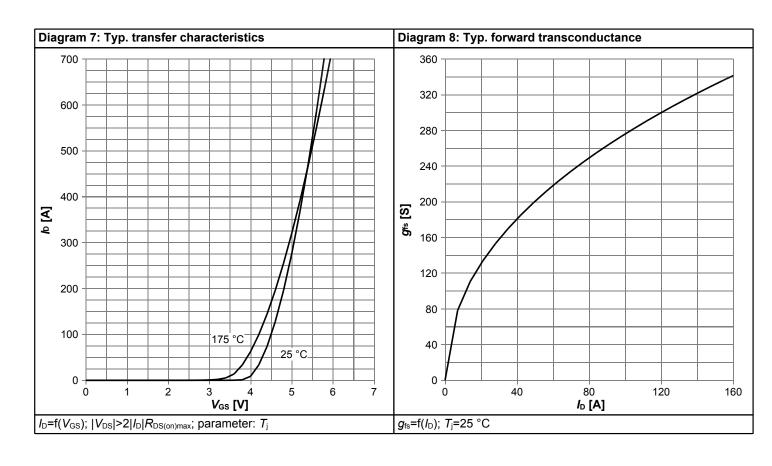
## 4 Electrical characteristics diagrams



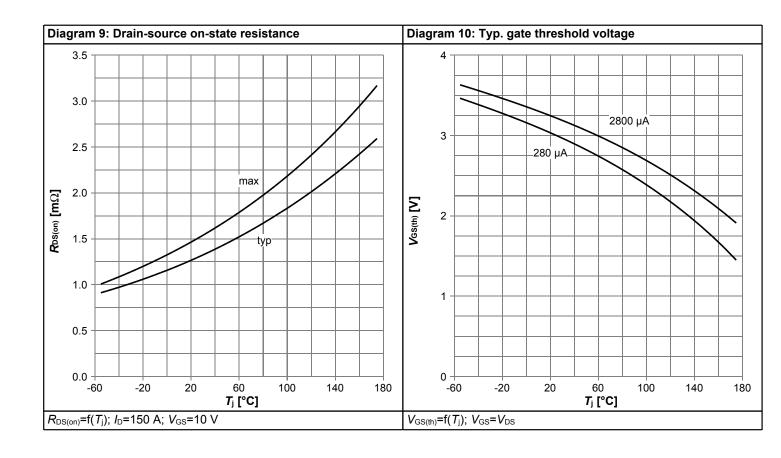


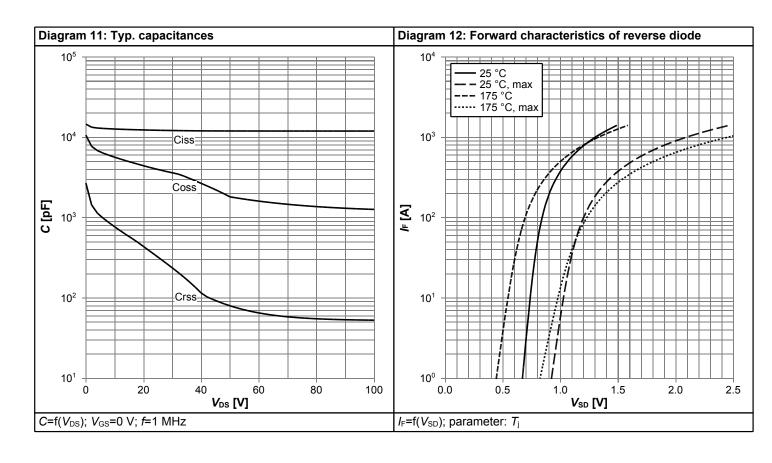




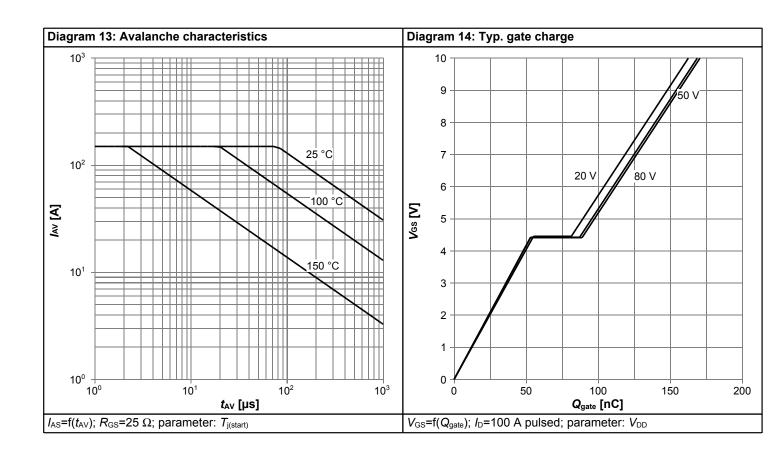


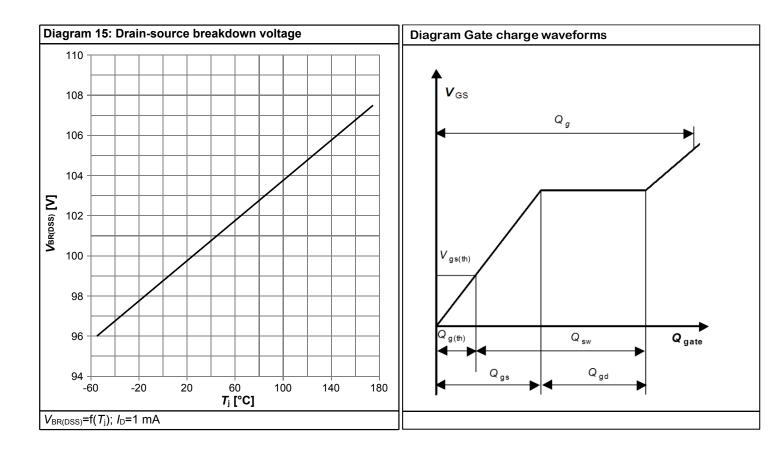














# 5 Package Outlines

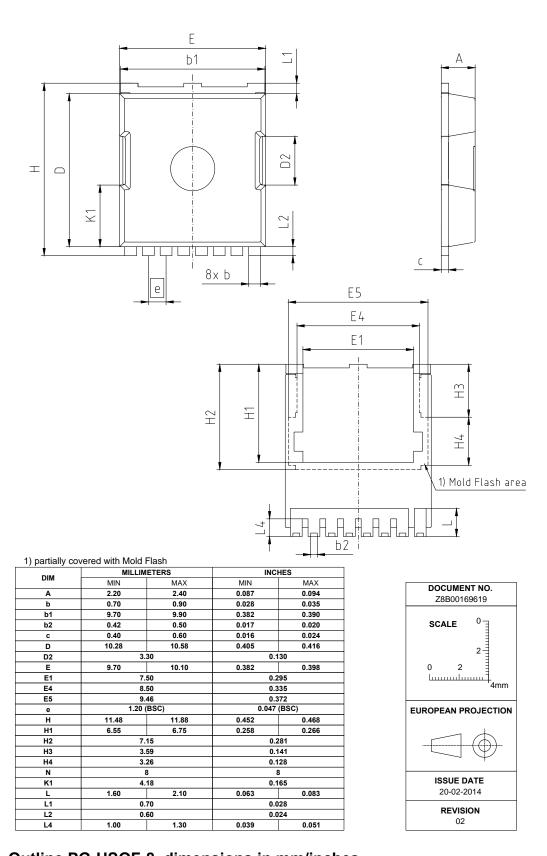


Figure 1 Outline PG-HSOF-8, dimensions in mm/inches

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### **Revision History**

IPT015N10N5

Revision: 2023-05-04, Rev. 2.4

Drawiana	Revision
PIAMMIC	RAWKINN

Revision	Date	Subjects (major changes since last revision)
2.0	2014-12-17	Release of final version
2.1	2015-02-23	Correction of SOA area with Ipulse = 1200A
2.2	2016-10-13	Update Avalanche Energy
2.3	2017-05-31	Update "Tc" condition in "Continous drain current"
2.4	2023-05-04	Update current rating

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